

FPF1103 / FPF1104 **Advance Load Management Switch**

Features

- - 55mΩ at V_{IN}=1.8V
- Output Discharge Function on FPF1104
- Low <1µA Quiescent Current at V_{ON}=V_{IN}
- ESD Protected: Above 4000V HBM, 2000V CDM
- GPIO/CMOS-Compatible Enable Circuitry

Applications

- Mobile Devices and Smart Phones
- Portable Media Devices
- Advanced Notebook, UMPC, MID

Ordering Information

| Part Number | Part Marking | Switch (Typical) At 1.8V _{IN} | Input Buffer | Output Discharge | ON Pin Activity | t _R | Eco Status | Package |
|----------------|-----------------|--|-----------------|---------------------|--------------------|----------------|---------------|--|
| FPF1103 | Q9 | 55mΩ | CMOS | NA | Active HIGH | 65µs | Green | 4-Ball, Wafer-Level Chip- |
| FPF1104 | QA | 55mΩ | CMOS | 65Ω | Active HIGH | 65µs | Green | Scale Package (WLCSP), 1.0 x 1.0mm, 0.5mm Pitch |

Ø For Fairchild's definition of Eco Status, please visit: <u>http://www.fairchildsemi.com/company/green/rohs_green.html</u>.

1.2V to 4V Input Voltage Operating Range

Typical RDS(ON):

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- 35mΩ at V_{IN}=3.3V
- 85mΩ at V_{IN}=1.2V
- Slew Rate Control with t_R: 65µs

- **Digital Cameras**

 - Portable Medical Devices
 - GPS and Navigation Equipment

Description

The FPF1103/04 are low R_{DS} P-channel MOSFET load switches of the IntelliMAX[™] family. Integrated slew-rate control prevents inrush current from glitch supply rails with capacitive loads common in power applications.

The input voltage range operates from 1.2V to 4V to fulfill today's lowest ultra-portable device supply requirements. Switch control is by a logic input (ON-pin) capable of interfacing directly with low-voltage CMOS control signals and GPIOs in embedded processors.





Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Paramet | Min. | Max. | Unit | |
|------------------|---|--------------------------------------|------|------|------|
| V _{IN} | V _{IN} , V _{OUT} , V _{ON} to GND | | -0.3 | 4.2 | V |
| I _{SW} | Maximum Continuous Switch Current | | | 1.2 | А |
| PD | Power Dissipation at T _A =25°C | | | 1.0 | W |
| T _{STG} | Storage Junction Temperature | | -65 | +150 | °C |
| T _A | Operating Temperature Range | | -40 | +85 | °C |
| | Thermal Desistance, Junction to Ambient | 1S2P with 1 Thermal Via | | 95 | °C/W |
| Θ_{JA} | Thermal Resistance, Junction-to-Ambient | 1S2P without Thermal Via | - | 187 | C/W |
| FOD | Electrostatia Discharge Conshility | Human Body Model, JESD22-A114 | 4 | | |
| ESD | Electrostatic Discharge Capability | Charged Device Model, JESD22-C101 | 2 | | kV |

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Unit |
|-----------------|-------------------------------|------|------|------|
| V _{IN} | Supply Voltage | 1.2 | 4.0 | V |
| TA | Ambient Operating Temperature | -40 | +85 | °C |

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| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units | |
|------------------------|---|--|-------|------|------|-------|--|
| Basic Ope | ration | l | | | | | |
| V _{IN} | Supply Voltage | | 1.2 | | 4.0 | V | |
| I _{Q(OFF)} | Off Supply Current | V _{ON} =GND, V _{OUT} =Open, V _{IN} =4V | | | 1 | μA | |
| I _{SD(OFF)} | Off Switch Current | V _{ON} =GND, V _{OUT} =GND | | | 1 | μA | |
| | | I _{OUT} =0mA, V _{ON} =V _{IN} | | | 1 | | |
| Ι _Q | Quiescent Current | I _{OUT} =0mA, V _{ON} < V _{IN} | 3 | | | μA | |
| | | V _{IN} =3.3V, I _{OUT} =200mA, T _A =25°C | 35 50 | | 50 | | |
| | | V _{IN} =1.8V, I _{OUT} =200mA, T _A =25°C | | 55 | 70 | | |
| Ron | On-Resistance | V _{IN} =1.5V, I _{OUT} =200mA, T _A =25°C | | | | mΩ | |
| | | V _{IN} =1.2V, I _{OUT} =200mA, T _A =25°C | | 85 | 150 | 1 | |
| | | V _{IN} =1.8V, I _{OUT} =200mA, T _A =85°C ⁽³⁾ | | 65 | 100 | l | |
| R _{PD} | Output Discharge RPULL DOWN | V _{IN} =3.3V, V _{ON} =0V, I _{FORCE} =20mA, T _A =25°C, FPF1104 | | 65 | 110 | Ω | |
| VIH | ON Input Logic High Voltage | V _{IN} =1.2V to 4.0V | 1.1 | | | V | |
| VIL | ON Input Logic Low Voltage | V _{IN} =1.2V to 4.0V | | | 0.35 | V | |
| I _{ON} | ON Input Leakage | V _{ON} =V _{IN} or GND | -1 | | 1 | μA | |
| Dynamic C | haracteristics | | 1 | | | | |
| t _{DON} | Turn-On Delay ⁽⁴⁾ | | | 35 | | μs | |
| t _R | V _{OUT} Rise Time ⁽⁴⁾ | V _{IN} =3.3V, R _L =10Ω, C _L =0.1μF, T _A =25°C | | 65 | | μs | |
| t _{on} | Turn-On Time ^(4,6) | T _A -25 C | | 100 | | μs | |
| t _{DON} | Turn-On Delay ⁽⁴⁾ | | | 30 | 50 | μs | |
| t _R | V _{OUT} Rise Time ⁽⁴⁾ | V _{IN} =3.3V, R _L =500Ω, C _L =0.1µF, | | 40 | 55 | μs | |
| t _{ON} | Turn-On Time ^(4,6) | T _A =25°C | | 70 | 105 | μs | |
| PF1103 | | | | | | | |
| tDOFF | Turn-Off Delay ⁽⁴⁾ | elay ⁽⁴⁾ | | 2.0 | 2.5 | μs | |
| t⊨ | V _{OUT} Fall Time ⁽⁴⁾ | $V_{IN}=3.3V, R_L=10\Omega, C_L=0.1\mu F,$ | | 2.2 | | μs | |
| toff | Turn-Off ^(4,7) | - T _A =25°C | | 4.2 | | μs | |
| t _{DOFF} | Turn-Off Delay ⁽⁴⁾ | | 1 | 7.0 | | μs | |
| t⊧ | V _{OUT} Fall Time ⁽⁴⁾ | V _{IN} =3.3V, R _L =500Ω, C _L =0.1µF, | | 110 | y a | μs | |
| t _{OFF} | Turn-Off ^(4,7) | T _A =25°C | | 117 | | μs | |
| FPF1104 ⁽⁵⁾ | | • | | | | | |
| t _{DOFF} | Turn-Off Delay ⁽⁴⁾ | | | 2.0 | 2.5 | μs | |
| t⊧ | V _{OUT} Fall Time ⁽⁴⁾ | V_{IN} =3.3V, R _L =10Ω, C _L =0.1µF, | | 1.9 | | μs | |
| toFF | Turn-Off ^(4,7) | R _{PD} =65Ω, T _A =25°C | | 3.9 | | μs | |
| t _{DOFF} | Turn-Off Delay ⁽⁴⁾ | | | 2.5 | | μs | |
| t _F | V _{OUT} Fall Time ⁽⁴⁾ | V_{IN} =3.3V, R _L =500 Ω , C _L =0.1 μ F, | | 10.6 | | μs | |
| t _{OFF} | Turn-Off ^(4,7) | $R_{PD}=65\Omega, T_{A}=25^{\circ}C$ | | 13.1 | | μs | |

Notes:

This parameter is guaranteed by design and characterization; not production tested. $t_{DON}/t_{DOFF}/t_R/t_F$ are defined in Figure 7. Output discharge path is enabled during off. 3.

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FPF1103 / FPF1104 — Advance Load Management Switch

Application Information

Input Capacitor

An IntelliMAXTM switch doesn't require an input capacitor. To reduce device inrush current effect, a 0.1μ F ceramic capacitor, C_{IN}, is recommended close to the VIN pin. A higher value of C_{IN} can be used to further reduce the voltage drop experienced as the switch is turned on into a large capacitive load.

Output Capacitor

An IntelliMAXTM switch works without an output capacitor. However, if parasitic board inductance forces V_{OUT} below GND when switching off, a 0.1µF capacitor, C_{OUT} , should be placed between V_{OUT} and GND.

Fall Time

Device output fall time can be calculated based on RC constant of the external components as follows:

$$t_{\rm F} = R_{\rm L} \times C_{\rm L} \times 2.2 \tag{1}$$

where t_F is 90% to 10% fall time, R_L is output load, and C_L is output capacitor.

The same equation works for a device with a pull-down output resistor. R_L is replaced by a parallel connected pull-down and an external output resistor combination, as follows:

$$t_{\rm F} = \frac{R_{\rm L} \times R_{\rm PD}}{R_{\rm L} + R_{\rm PD}} \times C_{\rm L} \times 2.2 \tag{2}$$

where t_F is 90% to 10% fall time, R_L is output load, $R_{\text{PD}}\text{=}65\Omega.\text{is}$ output pull-down resistor, and C_L is the output capacitor.

Resistive Output Load

If resistive output load is missing, the IntelliMAXTM switch without a pull-down output resistor is not discharging the output voltage. Output voltage drop depends, in that case, mainly on external device leaks.

Recommended Land Pattern and Layout

For best thermal performance and minimal inductance and parasitic effects, it is recommended to keep input and output traces short and capacitors

as close to the device as possible. Below is a recommended layout for this device to achieve optimum performance.



Figure 28. Recommended Land Pattern and Layout



Product-Specific Dimensions

| Product | D | E | x | Y |
|---------|--------------|--------------|---------|---------|
| FPF1103 | 960µm ± 30µm | 960µm ± 30µm | 0.230mm | 0.230mm |
| FPF1104 | 960um ± 30µm | 960um ± 30µm | 0.230mm | 0.230mm |

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|--------------------------|-----------------------|---|
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